

RESONANT SILICON FORCE AND PRESSURE SENSORS BASED ON PIEZOELECTRIC THIN FILMS

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Abstract

This paper presents resonant force and pressure sensors with semi-digital frequency output comprising piezoelectric ZnO thin films for excitation and detection of the beam and diaphragm resonators. Special emphasis is put on the technological process integration, i.e. passivation of the ZnO layer and separation of the beam structures. An elaborate sensor design was achieved by patterning of the electrodes to optimize mode selectivity and minimizing electrical cross-talk effects.

The fabrication process of the sensor devices consists of p⁺⁺-doping and backside wet etching of the membranes in <100>-silicon substrate. The piezoelectric ZnO transducer layer is deposited by rf-sputtering and subsequently wet etched. Top electrodes were realized by Al-metalization and following passivation. The resonator beams of the force sensor are separated by plasma etching techniques, i.e. propagation ion etching (PIE) with high selectivity and high etch rates up to 10 µm/min in silicon.

Extensive finite element modeling has been carried out to determine the static and dynamic behaviour and to obtain an optimum sensor performance. Considering the piezoelectric excitation, the effective electromechanical coupling factor and the impedance/phase-characteristics of the sensor devices were calculated leading to an optimum thickness of the ZnO layer.

The resonant sensors have been experimentally characterized by means of optical and electrical measurement techniques and show a good mode selectivity, high force and pressure sensitivities combined with a low temperature cross-sensitivity. Investigations of the long term stability due to load and temperature cycles have been carried out successfully.